



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
 United States Patent and Trademark Office
 Address: COMMISSIONER FOR PATENTS
 P.O. Box 1450
 Alexandria, Virginia 22313-1450
 www.uspto.gov



Bib Data Sheet

CONFIRMATION NO. 3494

SERIAL NUMBER 10/802,563	FILING DATE 03/17/2004 RULE	CLASS 257	GROUP ART UNIT 2823	ATTORNEY DOCKET NO. NUS03-001
-----------------------------	---------------------------------------	--------------	------------------------	-------------------------------------

APPLICANTS

Hong Yu Yu, Singapore, SINGAPORE;

 Ming-Fu Li, Singapore, SINGAPORE;
 Dim-Lee Kwong, Austin, TX; Lakshmi Kanta Bera, Singapore, SINGAPORE;

** CONTINUING DATA *****

NO SK

** FOREIGN APPLICATIONS *****

NO SK

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 06/01/2004

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR	SHEETS	TOTAL	INDEPENDENT
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Allowance	COUNTRY	DRAWING	CLAIMS	CLAIMS
Verified and Acknowledged Examiner's Signature: <i>[Signature]</i> Initials: <i>SK</i>	SINGAPORE	4	34	4

ADDRESS

 STEPHEN B. ACKERMAN
 28 DAVIS AVENUE
 POUGHKEEPSIE, NY
 12603

TITLE

Thermal robust semiconductor device using HfN as metal gate electrode and the manufacturing process thereof

FILING FEE RECEIVED 1108	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue)
------------------------------------	---	--